P3C1256 HIGH SPEED 32K x 8 3.3V STATIC CMOS RAM



FEATURES

- 3.3V Power Supply
- High Speed (Equal Access and Cycle Times)
 - 12/15/20/25 ns (Commercial)
 - 15/20/25 ns (Industrial)
- Low Power
 - 360 mW Active
- Single 3.3 Volts ±0.3 Volts Power Supply
- Easy Memory Expansion Using CE and OE Inputs

- Common Data I/O
- **■** Three-State Outputs
- **■** Fully TTL Compatible Inputs and Outputs
- Advanced CMOS Technology
- Automatic Power Down
- Packages
 - -28-Pin 300 mil DIP and SOJ



DESCRIPTION

The P3C1256 is a 262,144-bit high-speed CMOS static RAM organized as 32Kx8. The CMOS memory requires no clocks or refreshing, and has equal access and cycle times. Inputs are fully TTL-compatible. The RAM operates from a single $3.3V\pm0.3V$ tolerance power supply.

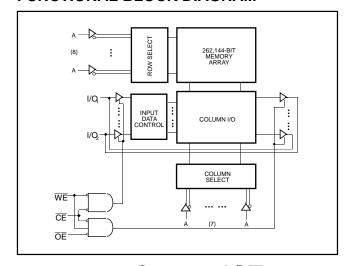
Access times as fast as 12 nanoseconds permit greatly enhanced system operating speeds. CMOS is utilized to reduce power consumption to a low level. The P3C1256 is a member of a family of PACE RAM™ products offering fast access times.

The P3C1256 device provides asynchronous operation with matching access and cycle times. Memory locations are specified on address pins A_0 to A_{14} . Reading is accomplished by device selection (\overline{CE} and output enabling (\overline{OE}) while write enable (\overline{WE}) remains HIGH. By presenting the address under these conditions, the data in the addressed memory location is presented on the data input/output pins. The input/output pins stay in the HIGH Z state when either \overline{CE} or \overline{OE} is HIGH or \overline{WE} is LOW.

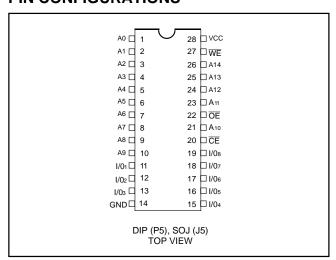
Package options for the P3C1256 include 28-pin 300 mil DIP and SOJ packages.



FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATIONS





Means Quality, Service and Speed

RECOMMENDED OPERATING TEMPERATURE & SUPPLY VOLTAGE

Temperature Range (Ambient)	Supply Voltage
Commercial (0°C to 70°C)	$3.0V \le V_{CC} \le 3.6V$
Industrial (-40°C to 85°C)	3.0 ≤ V _{CC} ≤ 3.6V

MAXIMUM RATINGS

Stresses greater than those listed can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this data sheet. Exposure to Maximum Ratings for extended periods can adversely affect device reliability.

Symbol	Parameter	Min	Max	Unit
V _{cc}	Supply Voltage with Respect to GND	-0.5	7.0	V
V _{TERM}	Terminal Voltage with Respect to GND (up to 7.0V)	-0.5	V _{cc} + 0.5	V
T _A	Operating Ambient Temperature	-40	85	°C
S _{TG}	Storage Temperature	-55	125	°C
I _{OUT}	Output Current into Low Outputs		25	mA
I _{LAT}	Latch-up Current	>200		mA

DC ELECTRICAL CHARACTERISTICS

(Over Recommended Operating Temperature & Supply Voltage)

Symbol	Parameter	Test Conditions	Min	Max	Unit
V _{OH}	Output High Voltage (I/O ₀ - I/O ₇)	$I_{OH} = -4mA$, $V_{CC} = 3.0V$	2.4		V
V _{oL}	Output Low Voltage (I/O ₀ - I/O ₈)	I _{OL} = 8 mA I _{OL} = 10 mA		0.4 0.5	V V
V _{IH}	Input High Voltage		2.2	V _{cc} + 0.3	V
V _{IL}	Input Low Voltage		-0.5	0.8	V
I _{LI}	Input Leakage Current	$GND \le V_{IN} \le V_{CC}$	-5	+5	μΑ
I _{LO}	Output Leakage Current	$\frac{GND \le V_{OUT} \le V_{CC}}{CE} = V_{CC}$	-5	+5	μΑ
I _{SB}	V _{cc} Current TTL Standby Current	$V_{CC} = 3.6V, I_{OUT} = 0 \text{ mA}$ $\overline{CE} = V_{CC}$		20	mA
I _{SB1}	V _{cc} Current CMOS Standby Current	$V_{CC} = 3.6V$, $I_{OUT} = 0$ mA $\overline{CE} = V_{CC}$		3	mA

CAPACITANCES

 $(V_{CC} = 5.0V, T_A = 25^{\circ}C, f = 1.0 MHz)$

Symbol	Parameter	Test Conditions	Max	Unit
C _{IN}	Input Capacitance	$V_{IN} = 0V$	10	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V	10	pF

POWER DISSIPATION CHARACTERISTICS VS. SPEED

Symbol	Parameter	Temperature Range	Test Conditions	-12	-15	-20	-25	Unit
I _{cc}	Dynamic Operating Current	Commercial Industrial	*	110 N/A	100 115	95 110	90 105	mA mA

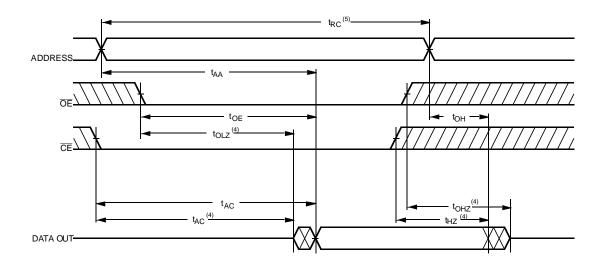
^{*}Tested with outputs open and all address and data inputs changing at the maximum write-cycle rate. The device is continuously enabled for writing, i.e., \overline{CE} , and $\overline{WE} \le V_{IL}$ (max), \overline{OE} is high. Switching inputs are 0V and 3V

AC ELECTRICAL CHARACTERISTICS - READ CYCLE

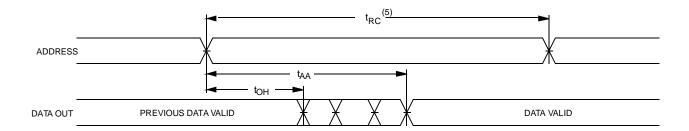
(Over Recommended Operating Temperature & Supply Voltage)

0	D		12		15	-2	20	-2	25	Unit
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Min	Max	Unit
t _{RC}	Read Cycle Time	12		15		20		25		ns
t _{AA}	Address Access Time		12		15		20		25	ns
t _{AC}	Chip Enable Access Time		12		15		20		25	ns
t _{OH}	Output Hold from Address Change	2		2		2		2		ns
t _{LZ}	Chip Enable to Output in Low Z	2		2		2		2		ns
t _{HZ}	Chip Disable to Output in High Z		7		8		9		10	ns
t _{OE}	Output Enable Low to Data Valid		7		9		11		12	ns
t _{OLZ}	Output Enable Low to Low Z	0		0		0		0		ns
t _{oHZ}	Output Enable High to High Z		6		7		9		10	ns
t _{PU}	Chip Enable to Power Up Time	0		0		0		0		ns
t _{PD}	Chip Disable to Power Down Time		12		15		20		20	ns

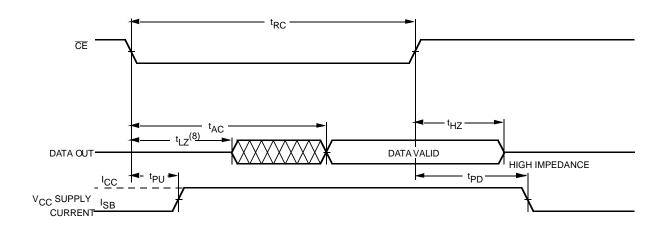
READ CYCLE NO. 1 (OE CONTROLLED)(1)



READ CYCLE NO. 2 (ADDRESS CONTROLLED)



READ CYCLE NO. 3 (CE CONTROLLED)



Notes:

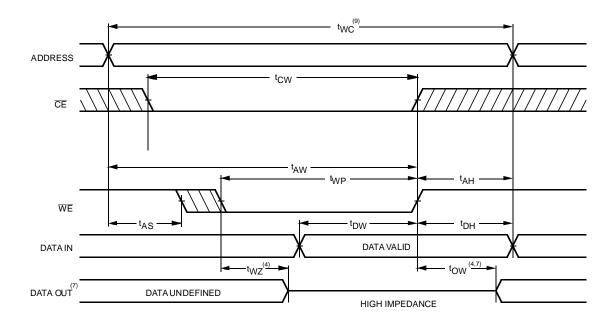
- 1. $\overline{\text{WE}}$ is HIGH for READ cycle.
- 2. $\overline{\text{CE}}_1$ is LOW, $\overline{\text{CE}}_2$ is HIGH and $\overline{\text{OE}}$ is LOW for READ cycle. 3. ADDRESS must be valid prior to, or coincident with $\overline{\text{CE}}_1$ transition LOW.
- 4. Transition is measured $\pm\,200~\text{mV}$ from steady state voltage prior to change, with loading as specified in Figure 1. This parameter is sampled and not 100% tested.
- 5. READ Cycle Time is measured from the last valid address to the first transitioning address.

AC CHARACTERISTICS—WRITE CYCLE

(Over Recommended Operating Temperature & Supply Voltage)

Cumbal	Doromotor	-1	2		15	-2	-20		25	Unit
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Min	Max	Oilit
t _{wc}	Write Cycle Time	12		15		20		25		ns
t _{cw}	Chip Enable Time to End of Write	10		12		15		18		ns
t _{AW}	Address Valid to End of Write	10		12		15		18		ns
t _{AS}	Address Set-up Time	0		0		0		0		ns
t _{WP}	Write Pulse Width	9		11		15		18		ns
t _{AH}	Address Hold Time	0		0		0		0		ns
t _{DW}	Data Valid to End of Write	8		10		12		15		ns
t _{DH}	Data Hold Time	0		0		0		0		ns
t _{wz}	Write Enable to Output in High Z		7		8		10		11	ns
t _{ow}	Output Active from End of Write	3		3		3		3		ns

WRITE CYCLE NO. 1 (WE CONTROLLED)(6)

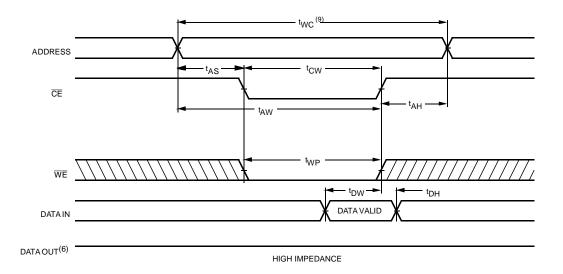


- 6. \overline{CE}_1 and \overline{WE} must be LOW for WRITE cycle.

 7. \overline{OE} is LOW for this WRITE cycle to show t_{WZ} and t_{OW} .

 8. If \overline{CE}_1 goes HIGH simultaneously with \overline{WE} HIGH, the output remains in a high impedance state.
- 9. Write Cycle Time is measured from the last valid address to the first transitioning address.

TIMING WAVEFORM OF WRITE CYCLE NO. 2 (CE CONTROLLED)(6)



AC TEST CONDITIONS

Input Pulse Levels	GND to 3.0V
Input Rise and Fall Times	3ns
Input Timing Reference Level	1.5V
Output Timing Reference Level	1.5V
Output Load	See Figures 1 and 2

TRUTH TABLE

Mode	CE	ŌĒ	WE	Ī/O	Power
Standby	Н	Х	Х	High Z	Standby
Standby	Х	Х	Х	High Z	Standby
D _{OUT} Disabled	L	Н	Н	High Z	Active
Read	L	L	Н	D _{OUT}	Active
Write	L	Х	L	High Z	Active

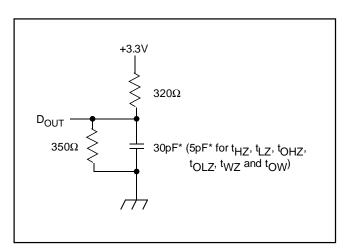


Figure 1. Output Load

Figure 2. Thevenin Equivalent

Note:

Because of the ultra-high speed of the P3C1256, care must be taken when testing this device; an inadequate setup can cause a normal functioning part to be rejected as faulty. Long high-inductance leads that cause supply bounce must be avoided by bringing the $V_{\rm cc}$ and ground planes directly up to the contactor fingers. A 0.01 μF high frequency capacitor is also required between $V_{\rm cc}$ and ground. To avoid signal

reflections, proper termination must be used; for example, a 50Ω test environment should be terminated into a 50Ω load with 1.73V (Thevenin Voltage) at the comparator input, and a 116Ω resistor must be used in series with D_{OUT} to match 166Ω (Thevenin Resistance).

 $R_{TH} = 167.2 \Omega$ $D_{OUT} \longrightarrow V_{TH} = 1.72V$ $30pF^* (5pF^* for t_{HZ}, t_{LZ}, t_{OHZ}, t_{OLZ}, t_{WZ} and T_{OW})$

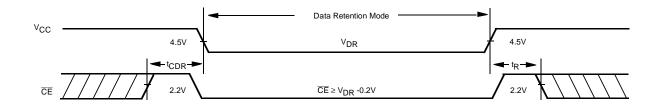
^{*} including scope and test fixture.

DATA RETENTION

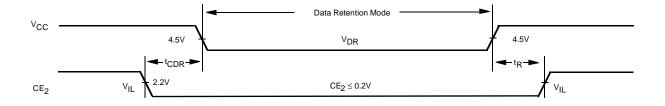
Symbol	Parameter	Test Conditions	Min	Max	Unit
V _{DR}	V _{cc} for Data Retention	$\overline{\text{CE}} \ge \text{V}_{\text{CC}}$ -0.2V, $\text{CE}_2 \le 0.2\text{V}$ $\text{V}_{\text{IN}} \ge \text{V}_{\text{CC}}$ -0.2V or $\text{V}_{\text{IN}} \le 0.2\text{V}$	2.0	3.6	V
I _{CCDR} ⁽¹⁾	Data Retention Current	V _{DR} = 2.0V		600	μΑ
t _{CDR}	Chip Deselect to Data Retention Time	See Retention Waveform	0		ns
t _R	Operating Recovery Time		t _{RC} ⁽²⁾		ns

^{1.} $\overline{\text{CE}}_1 \ge \text{V}_{\text{DR}}$ -0.2V, $\text{CE}_2 \ge \text{V}_{\text{DR}}$ -0.2V or $\text{CE}_2 \le 0.2\text{V}$; or $\overline{\text{CE}}_1 \le 0.2\text{V}$, $\text{CE}_2 \le 0.2\text{V}$; $\text{V}_{\text{IN}} \ge \text{V}_{\text{DR}}$ -0.2V or $\text{V}_{\text{IN}} \le 0.2\text{V}$ 2. $\text{t}_{\text{RC}} = \text{Read Cycle Time}$

LOW V_{cc} DATA RETENTION WAVEFORM (1) ($\overline{\text{CE}}_{\scriptscriptstyle{1}}$ CONTROLLED)



LOW $V_{\rm cc}$ DATA RETENTION WAVEFORM (2) (CE $_{\scriptscriptstyle 2}$ CONTROLLED)



PACKAGE SUFFIX

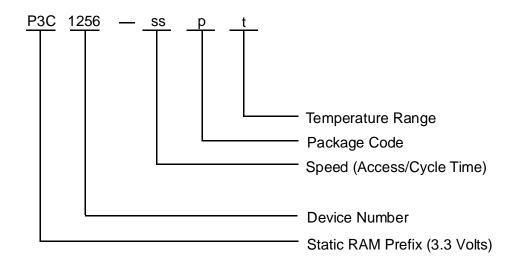
Package Suffix	Description
P	Plastic DIP, 300 mil wide standard
J	Plastic SOJ, 300 mil wide standard

TEMPERATURE RANGE SUFFIX

Temperature Range Suffix	Description
С	Commercial Temperature Range, 0°C to +70°C.
I	Industrial Temperature Range, –40°C to +85°C.

ORDERING INFORMATION

Performance Semiconductor's part numbering scheme is as follows:



ss = Speed (access/cycle time in ns), e.g., 12, 15. p = Package code, i.e., P, J. t = Temperature range, i.e. C, I.

SELECTION GUIDE

The P3C1256 is available in the following temperature, speed and package options.

Temperature Range	Speed Package	12	15	20	25
Commercial	Plastic DIP	-12PC	-15PC	-20PC	-25PC
	Plastic SOJ	-12JC	-15JC	-20JC	-25JC
Industrial	Plastic DIP	N/A	-15PI	-20PI	-25PI
	Plastic SOJ	N/A	-15JI	-20JI	-25JI

N/A = Not Available